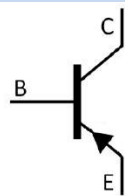


/ Descriptions

/ Features

/ Applications

/ Equivalent Circuit



/ Pinning



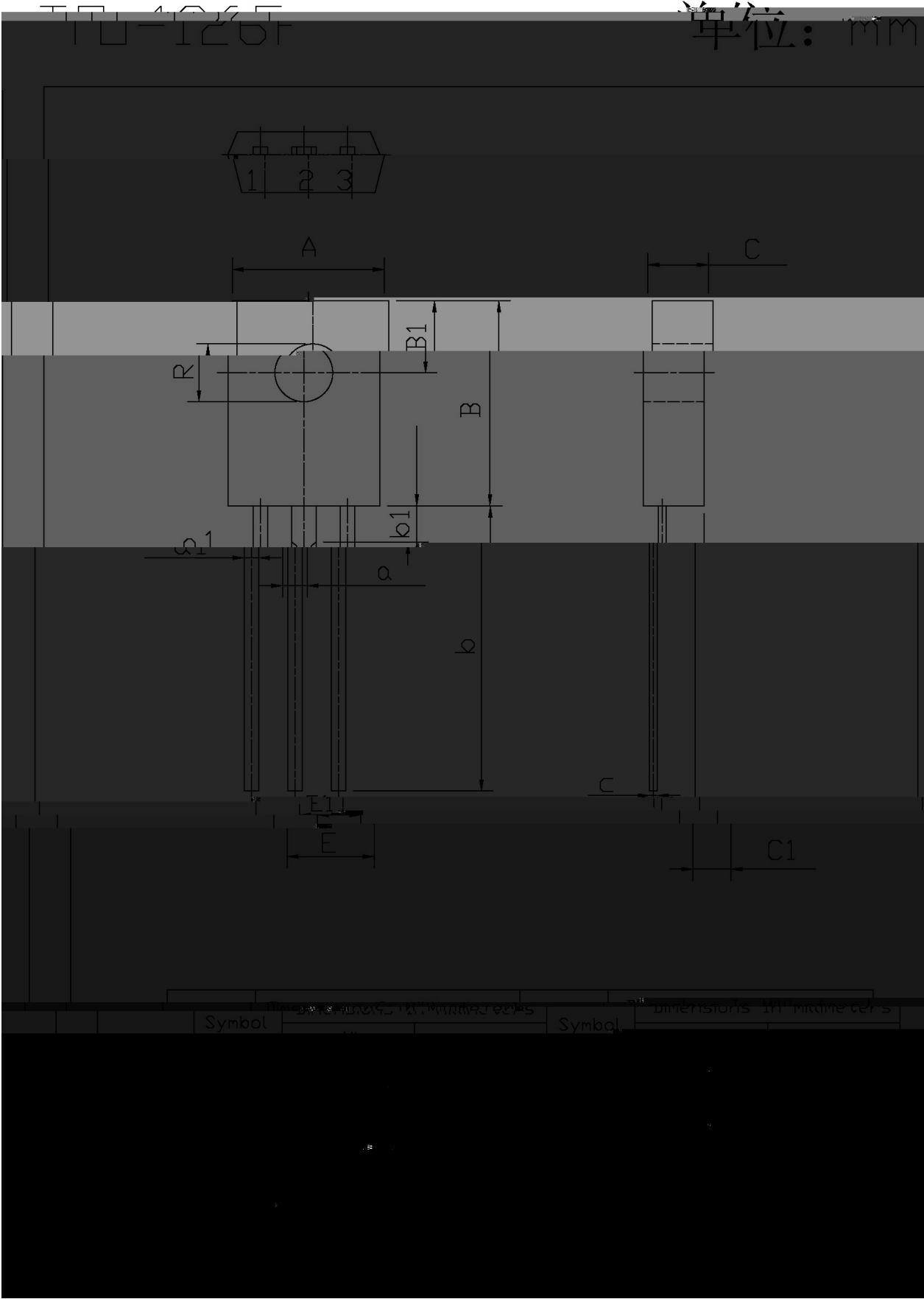
/ h_{FE} Classifications & Marking

	℃		
			℃
			℃

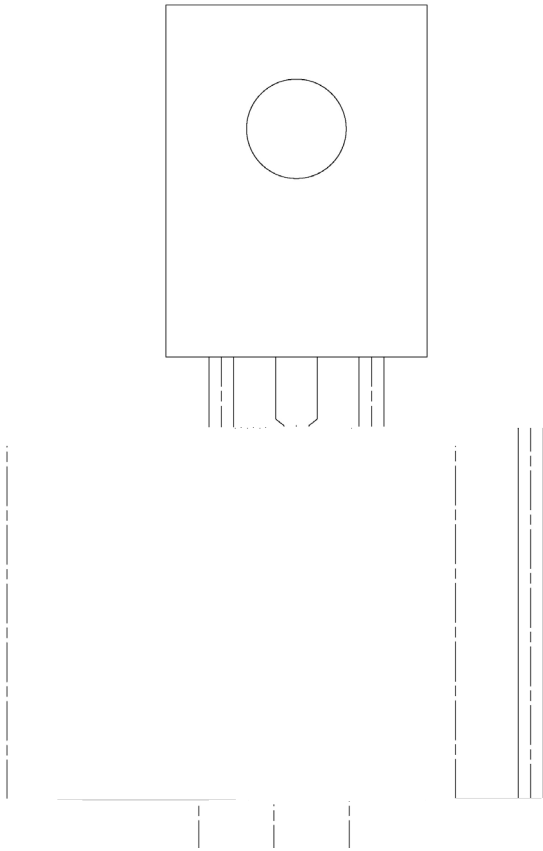
/ Electrical Characteristic Curve



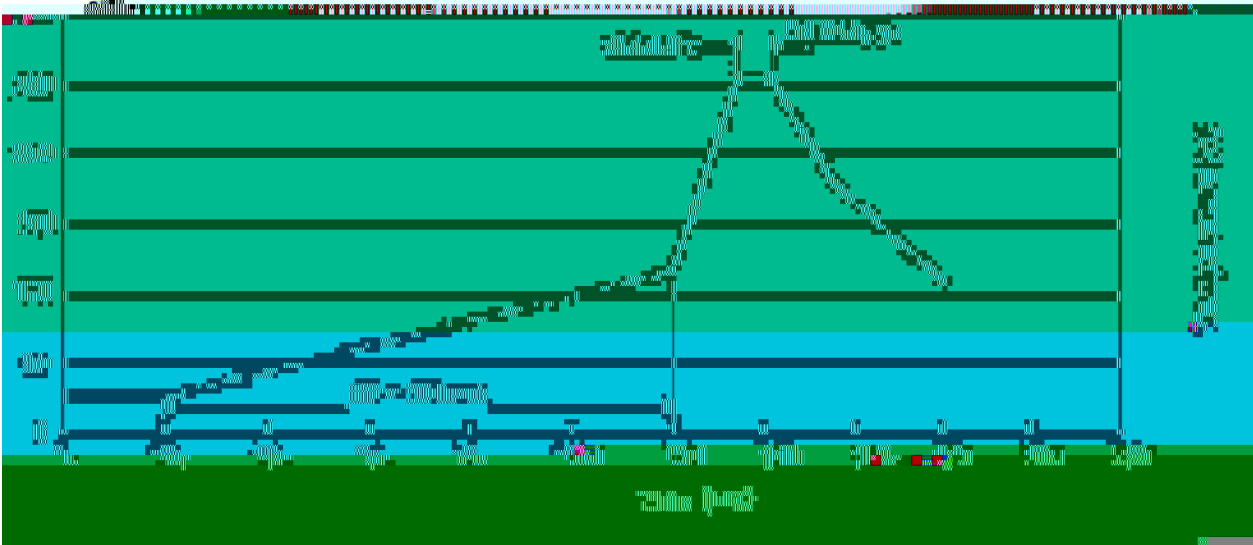
/ Package Dimensions



/ Marking Instructions



() / Temperature Profile for Dip Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

℃

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只 套管	套管 盒	只 盒	盒 箱	只 箱	套管	盒	箱

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